

# STI13005-H

## High voltage fast-switching NPN power transistor

#### Datasheet - production data

### Features

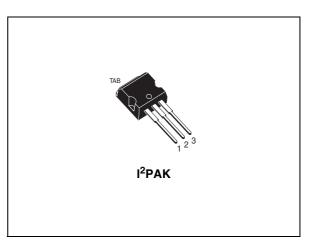
- Low spread of dynamic parameters
- Minimum lot-to-lot spread for reliable operation
- Very high switching speed

### **Applications**

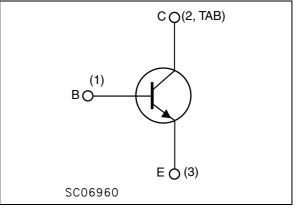
- Electronic ballast for fluorescent lighting
- Switch mode power supplies

## Description

This device is manufactured using high voltage multi epitaxial planar technology for high switching speeds and high voltage capability. It uses a cellular emitter structure with planar edge termination to enhance switching speeds while maintaining a wide RBSOA.



#### Figure 1. Internal schematic diagram



#### Table 1. Device summary

Order codes	Marking	Package	Packaging
STI13005-H	113005	I²PAK	Tube

This is information on a product in full production.

# 1 Electrical ratings

Table 2.	Absolute	maximum	ratings
	/10001010	maximani	raingo

Parameter	Value	Unit
Collector-emitter voltage (V <sub>BE</sub> = 0)	700	V
Collector-emitter voltage (I <sub>B</sub> = 0)	400	V
Emitter-base voltage (I <sub>C</sub> = 0)	9	V
Collector current	4	А
Collector peak current (t <sub>P</sub> < 5 ms)	8	А
Base current	2	А
Base peak current (t <sub>P</sub> < 5 ms)	4	А
Total dissipation at $T_c \le 25 \text{ °C}$		W
Storage temperature	- 65 to 150	°C
Max. operating junction temperature	150	°C
	Collector-emitter voltage ( $V_{BE} = 0$ )Collector-emitter voltage ( $I_B = 0$ )Emitter-base voltage ( $I_C = 0$ )Collector currentCollector peak current ( $t_P < 5 \text{ ms}$ )Base currentBase peak current ( $t_P < 5 \text{ ms}$ )Total dissipation at $T_c \le 25$ °CStorage temperature	Collector-emitter voltage ( $V_{BE} = 0$ )700Collector-emitter voltage ( $I_B = 0$ )400Emitter-base voltage ( $I_C = 0$ )9Collector current4Collector peak current ( $t_P < 5 \text{ ms}$ )8Base current2Base peak current ( $t_P < 5 \text{ ms}$ )4Total dissipation at $T_c \le 25 \text{ °C}$ 75Storage temperature-65 to 150

### Table 3. Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case max	1.7	°C/W
R <sub>thj-amb</sub>	Thermal resistance junction-amb max	62.5	°C/W

## 2 Electrical characteristics

 $T_{case}$  = 25 °C unless otherwise specified.

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>CES</sub>	Collector cut-off current $(V_{BE} = 0)$	V <sub>CE</sub> = 700 V V <sub>CE</sub> = 700 V T <sub>C</sub> =125 °C			1 5	mA mA
I <sub>EBO</sub>	Emitter cut-off current $(I_{\rm C} = 0)$	V <sub>EB</sub> = 9 V			1	mA
V <sub>CEO(sus)</sub> <sup>(1)</sup>	Collector-emitter sustaining voltage (I <sub>B</sub> = 0)	I <sub>C</sub> =10 mA	400			V
V <sub>CE(sat)</sub> <sup>(1)</sup>	Collector-emitter saturation voltage				0.5 0.6 1	V V V
V <sub>BE(sat)</sub> <sup>(1)</sup>	Base-emitter saturation voltage	$I_{C} = 1 A$ $I_{B} = 0.2 A$ $I_{C} = 2 A$ $I_{B} = 0.5 A$			1.2 1.6	V V
h <sub>FE</sub> <sup>(1)</sup>	DC current gain	$I_{C} = 1 A$ $V_{CE} = 5 V$ $I_{C} = 2 A$ $V_{CE} = 5 V$	16 8		32 40	
	Resistive load	I <sub>C</sub> = 2 A V <sub>CC</sub> = 125 A				
t <sub>s</sub>	Storage time	I <sub>B1</sub> = - I <sub>B2</sub> =0.4 A		2.2		μs
t <sub>f</sub>	Fall time	t <sub>p</sub> = 30 μs		0.2		μs

 Table 4.
 Electrical characteristics

1. Pulse test: pulse duration = 300  $\mu$ s, duty cycle  $\leq$  2 %.



## 2.1 Test circuits



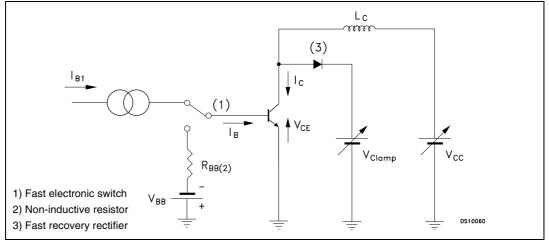
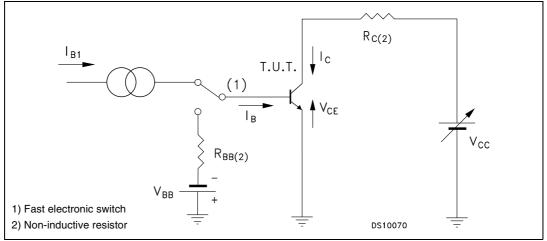


Figure 3. Resistive load switching test circuit





### 2.2 Electrical characteristics (curves)

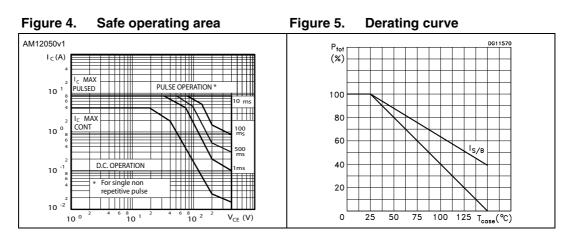
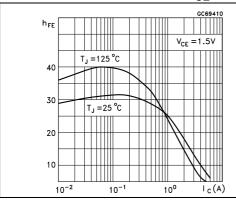
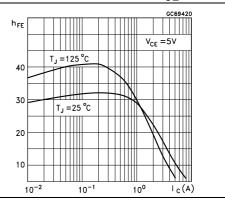
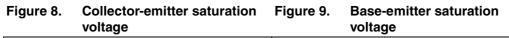
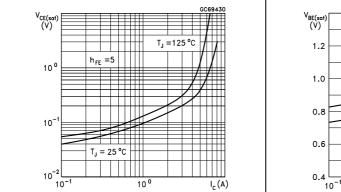


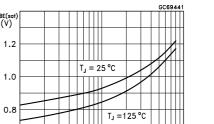
Figure 6. DC current gain ( $V_{CE} = 1.5 V$ ) Figure 7. DC current gain ( $V_{CE} = 5 V$ )











h<sub>FE</sub>=5

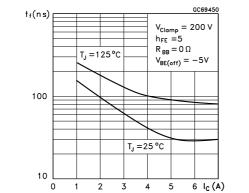
10<sup>0</sup>

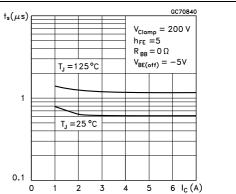
I<sub>c</sub>(A)





Figure 11. Inductive load storage time







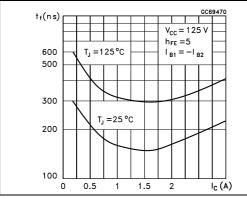
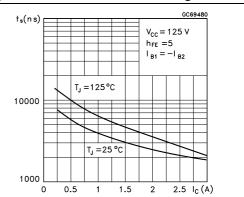
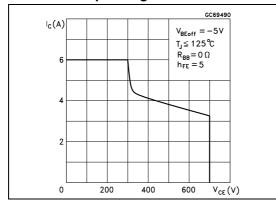


Figure 13. Resistive load storage time



# Figure 14. Reverse biased safe operating area





## 3 Package mechanical data

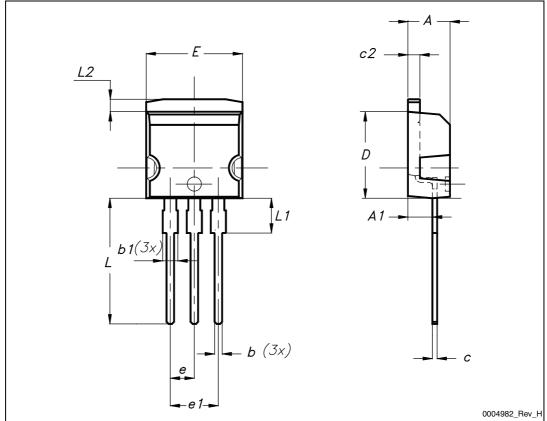
In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.



Table 5.	TPAR (TO-202) mechanica				
DIM.	mm.				
	min.	typ	max.		
А	4.40		4.60		
A1	2.40		2.72		
b	0.61		0.88		
b1	1.14		1.70		
С	0.49		0.70		
c2	1.23		1.32		
D	8.95		9.35		
е	2.40		2.70		
e1	4.95		5.15		
Е	10		10.40		
L	13		14		
L1	3.50		3.93		
L2	1.27		1.40		

 Table 5.
 I<sup>2</sup>PAK (TO-262) mechanical data

### Figure 15. I<sup>2</sup>PAK (TO-262) drawing





Doc ID 022937 Rev 1

## 4 Revision history

### Table 6.Document revision history

Date	Revision	Changes
19-Mar-2012	1	First release



#### Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY TWO AUTHORIZED ST REPRESENTATIVES, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2012 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan -Malaysia - Malta - Morocco - Philippines - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com

Doc ID 022937 Rev 1

